

Wireless Components

ASK/FSK Single Conversion Receiver

TDA 5211 Version 2.0

Specification May 2001

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Product Info

Product Info

General Description The IC is a very low power consump- Package

samples available

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Product Description

2.1 Overview

The IC is a very low power consumption single chip FSK/ASK Superheterodyne Receiver (SHR) for receive frequencies between 310 and 350 MHz that is pin compatible to the ASK Receiver TDA5201. The IC offers a high level of integration and needs only a few external components. The device contains a low noise amplifier (LNA), a double balanced mixer, a fully integrated VCO, a PLL synthesiser, a crystal oscillator, a limiter with RSSI generator, a PLL FSK demodulator, a data filter, a data comparator (slicer) and a peak detector. Additionally there is a power down feature to save battery life.

2.2 Application

- Keyless Entry Systems
- Remote Control Systems
- Alarm Systems
- Low Bitrate Communication Systems

2.3 Features

- Low supply current $(I_s = 5.7 \text{ mA}$ typ. FSK mode, 5mA typ. ASK mode)
- Supply voltage range 5V ±10%
- Power down mode with very low supply current (50nA typ.)
- FSK and ASK demodulation capability
- Fully integrated VCO and PLL Synthesiser
- RF input sensitivity ASK -113dBm typ. at 25°C, better than -110dBm over complete specified operating temperature range (-40 to +105°C)
- RF input sensitivity FSK -105dBm typ. at 25°C, better than -102dBm over complete specified operating temperature range (-40 to +105°C)
- Receive frequency range between 310 and 350 MHz
- Selectable reference frequency
- Limiter with RSSI generation, operating at 10.7MHz
- 2nd order low pass data filter with external capacitors
- Data slicer with self-adjusting threshold

P_TSSOP_28.EPS

2.4 Package Outlines

Figure 2-1 P-TSSOP-28-1 package outlines

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3.1 Pin Configuration

Figure 3-1 IC Pin Configuration

Pin_Configuration_5211.wmf

3.2 Pin Definition and Function

In the subsequent table the internal circuits connected to the pins of the device are shown. ESD-protection circuits are omitted to ease reading.

Functional Description

Infineon

Infineon

Infineon

3.3 Functional Block Diagram

Figure 3-2 Main Block Diagram

3.4 Functional Blocks

3.4.1 Low Noise Amplifier (LNA)

The LNA is an on-chip cascode amplifier with a voltage gain of 15 to 20dB. The gain figure is determined by the external matching networks situated ahead of LNA and between the LNA output **LNO** (Pin 6) and the Mixer Inputs **MI** and **MIX** (Pins 8 and 9). The noise figure of the LNA is approximately 3dB, the current consumption is 500µA. The gain can be reduced by approximately 18dB. The switching point of this AGC action can be determined externally by applying a threshold voltage at the **THRES** pin (Pin 23). This voltage is compared internally with the received signal (RSSI) level generated by the limiter circuitry. In case that the RSSI level is higher than the threshold voltage the LNA gain is reduced and vice versa. The threshold voltage can be generated by attaching a voltage divider between the **3VOUT** pin (Pin 24) which provides a temperature stable 3V output generated from the internal bandgap voltage and the **THRES** pin as described in [Section 4.1](#page-21-1). The time constant of the AGC action can be deter-

mined by connecting a capacitor to the **TAGC** pin (Pin 4) and should be chosen along with the appropriate threshold voltage according to the intended operating case and interference scenario to be expected during operation. The optimum choice of AGC time constant and the threshold voltage is described in [Section 4.1.](#page-21-1)

3.4.2 Mixer

The Double Balanced Mixer downconverts the input frequency (RF) in the range of 310-350MHz to the intermediate frequency (IF) at 10.7MHz with a voltage gain of approximately 21dB by utilising either high- or low-side injection of the local oscillator signal. In case the mixer is interfaced only single-ended, the unused mixer input has to be tied to ground via a capacitor. The mixer is followed by a low pass filter with a corner frequency of 20MHz in order to suppress RF signals to appear at the IF output (**IFO** pin). The IF output is internally consisting of an emitter follower that has a source impedance of approximately 330Ω to facilitate interfacing the pin directly to a standard 10.7MHz ceramic filter without additional matching circuitry.

3.4.3 PLL Synthesizer

The Phase Locked Loop synthesizer consists of a VCO, an asynchronous divider chain, a phase detector with charge pump and a loop filter and is fully implemented on-chip. The VCO is including spiral inductors and varactor diodes. The **FSEL** pin (Pin11) has to be left open. The tuning range of the VCO was designed to guarantee over production spread and the specified temperature range a receive frequency range between 310 and 350MHz depending on whether high- or low-side injection of the local oscillator is used. The oscillator signal is fed both to the synthesiser divider chain and to a divider that is dividing the signal by 2 before it is applied to the downconverting mixer. Local oscillator high side injection has to be used for receive frequencies between approximately 310 and 330 MHz, low side injection for receive frequencies between 330 and 350MHz - see also [Section 4.4.](#page-25-1).

3.4.4 Crystal Oscillator

The on-chip crystal oscillator circuitry allows for utilisation of quartzes both in the 5 and 10MHz range as the overall division ratio of the PLL can be switched between 32 and 64 via the **CSEL** (Pin 16) pin according to the following table.

The calculation of the value of the necessary quartz load capacitance is shown in [Section 4.3](#page-24-1), the quartz frequency calculation is explained in [Section 4.4.](#page-25-1)

3.4.5 Limiter

The Limiter is an AC coupled multistage amplifier with a cumulative gain of approximately 80 dB that has a bandpass-characteristic centred around 10.7 MHz. It has a typical input impedance of 330 Ω to allow for easy interfacing to a 10.7 MHz ceramic IF filter. The limiter circuit also acts as a Receive Signal Strength Indicator (RSSI) generator which produces a DC voltage that is directly proportional to the input signal level as can be seen in [Figure 4-2](#page-22-0). This signal is used to demodulate ASK-modulated receive signals in the subsequent baseband circuitry. The RSSI output is applied to the modulation format switch, to the Peak Detector input and to the AGC circuitry.

In order to demodulate ASK signals the MSEL pin has to be left open as described in the next chapter.

3.4.6 FSK Demodulator

To demodulate frequency shift keyed (FSK) signals a PLL circuit is used that is contained fully on chip. The Limiter output differential signal is fed to the linear phase detector as is the output of the 10.7 MHz center frequency VCO. The demodulator gain is typically 140µV/kHz. The passive loop filter output that is comprised fully on chip is fed to both the VCO and the modulation format switch described in more detail below. This signal is representing the demodulated signal with low frequencies applied to the demodulator demodulated to logic ones and high frequencies demodulated to logic zeroes. However this is only valid in case the local oscillator is low-side injected to the mixer which is applicable to receive frequencies above 330MHz (e.g. 345MHz). In case of receive frequencies below 330MHz (e.g.315MHz) high frequencies are demodulated as logical ones due to a sign inversion in the downconversion mixing process. See also [Section 4.4.](#page-25-1)

The modulation format switch is actually a switchable amplifier with an AC gain of 11 that is controlled by the **MSEL** pin (Pin 15) as shown in the following table. This gain was chosen to facilitate detection in the subsequent circuits. The DC gain is 1 in order not to saturate the subsequent Data Filter wih the DC offset produced by the demodulator in case of large frequency offsets of the IF signal. The resulting frequency characteristic and details on the principle of operation of the switch are described in [Section 4.6](#page-27-2).

The demodulator circuit is switched off in case of reception of ASK signals.

3.4.7 Data Filter

The data filter comprises an OP-Amp with a bandwidth of 100kHz used as a voltage follower and two 100kΩ on-chip resistors. Along with two external capacitors a 2nd order Sallen-Key low pass filter is formed. The selection of the capacitor values is described in [Section 4.2](#page-23-1).

3.4.8 Data Slicer

The data slicer is a fast comparator with a bandwidth of 100 kHz. This allows for a maximum receive data rate of up to 100kBaud. The maximum achievable data rate also depends on the IF Filter bandwidth and the local oscillator tolerance values. Both inputs are accessible. The output delivers a digital data signal (CMOS-like levels) for sbsequent circuits. The self-adjusting threshold on pin 20 its generated by RC-term or peak detector depending on the baseband coding scheme. The data slicer threshold generation alternatives are described in more detail in [Section 4.5](#page-26-1).

3.4.9 Peak Detector

The peak detector generates a DC voltage which is proportional to the peak value of the receive data signal. An external RC network is necessary. The input is connected to the output of the RSSI-output of the Limiter, the output is connected to the **PDO** pin (Pin 26). This output can be used as an indicator for the received signal strength to use in wake-up circuits and as a reference for the data slicer in ASK mode. The output current is typically 950µA, the discharge current is lower than 2µA. Note that the RSSI level is also output in case of FSK mode.

3.4.10 Bandgap Reference Circuitry

A Bandgap Reference Circuit provides a temperature stable reference voltage for the device. A power down mode is available to switch off all subcircuits which is controlled by the PWDN pin (Pin 27) as shown in the following table. The supply current drawn in this case is typically 50nA.

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4.1 Choice of LNA Threshold Voltage and Time Constant

In the following figure the internal circuitry of the LNA automatic gain control is shown.

LNA_autom.wmf

Figure 4-1 LNA Automatic Gain Control Circuitry

The LNA automatic gain control circuitry consists of an operational transimpedance amplifier that is used to compare the received signal strength signal (RSSI) generated by the Limiter with an externally provided threshold voltage U_{thres} . As shown in the following figure the threshold voltage can have any value between approximately 0.8 and 2.8V to provide a switching point within the receive signal dynamic range.

This voltage U_{thres} is applied to the THRES pin (Pin 23) The threshold voltage can be generated by attaching a voltage divider between the **3VOUT** pin (Pin 24) which provides a temperature stable 3V output generated from the internal bandgap voltage and the **THRES** pin. If the RSSI level generated by the Limiter is higher than U_{thres} , the OTA generates a positive current I_{load} . This yields a voltage rise on the **TAGC** pin (Pin 4). Otherwise, the OTA generates a negative current. These currents do not have the same values in order to achieve a fast-attack and slow-release action of the AGC and are used to charge an external capacitor which finally generates the LNA gain control voltage.

Figure 4-2 RSSI Level and Permissive AGC Threshold Levels

The switching point should be chosen according to the intended operating scenario. The determination of the optimum point is described in the accompanying Application Note, a threshold voltage level of 1.8V is apparently a viable choice. It should be noted that the output of the **3VOUT** pin is capable of driving up to 50µA, but that the **THRES** pin input current is only in the region of 40nA. As the current drawn out of the **3VOUT** pin is directly related to the receiver power consumption, the power divider resistors should have high impedance values. The sum of R1 and R2 has to be 600kΩ in order to yield 3V at the **3VOUT** pin. R1 can thus be chosen as 240kΩ, R2 as 360kΩ to yield an overall **3VOUT** output current of $5\mu A^1$ and a threshold voltage of 1.8V

Note: If the LNA gain shall be kept in either high or low gain mode this has to be accomplished by tying the **THRES** pin to a fixed voltage. In order to achieve high gain mode operation, a voltage higher than 2.8V shall be applied to the **THRES** pin, such as a short to the **3VOLT** pin. In order to achieve low gain mode operation a voltage lower than 0.7V shall be applied to the **THRES**, such as a short to ground.

As stated above the capacitor connected to the **TAGC** pin is generating the gain control voltage of the LNA due to the charging and discharging currents of the OTA and thus is also responsible for the AGC time constant. As the charging and discharging currents are not equal two different time constants will result. The time constant corresponding to the charging process of the capacitor shall be chosen according to the data rate. According to measurements performed at Infineon the capacitor value should be greater than 47nF.

1. note the 20kΩ resistor in series with the 3.1V internal voltage source

4.2 Data Filter Design

Utilising the on-board voltage follower and the two 100kΩ on-chip resistors a 2nd order Sallen-Key low pass data filter can be constructed by adding 2 external capacitors between pins 19 (SLP) and 22 (FFB) and to pin 21 (OPP) as depicted in the following figure and described in the following formulas¹.

 $(1)(2)$

$$
C1 = \frac{2Q\sqrt{b}}{R2\Pi f_{3dB}} \qquad C2 = \frac{\sqrt{b}}{4QR\Pi f_{3dB}}
$$

with

$$
Q = \frac{\sqrt{b}}{a}
$$

(3)the quality factor of the poles

where

in case of a Bessel filter $a = 1.3617$, $b = 0.618$ and thus $Q = 0.577$

and in case of a Butterworth filtera = 1.414 , $b = 1$ and thus $Q = 0.71$

Example: Butterworth filter with $f_{3dB} = 5kHz$ and R = 100kΩ:

$$
C_1 = 450pF, C_2 = 225pF
$$

1. taken from Tietze/Schenk: Halbleiterschaltungstechnik, Springer Berlin, 1999

4.3 Quartz Load Capacitance Calculation

The value of the capacitor necessary to achieve that the quartz oscillator is operating at the intended frequency is determined by the reactive part of the negative resistance of the oscillator circuit as shown in [Section 5.1.3](#page-36-1) and by the quartz specifications given by the quartz manufacturer.

Figure 4-4 Determination of Series Capacitance Value for the Quartz Oscillator

Crystal specified with load capacitance

$$
C_{S} = \frac{1}{\frac{1}{C_{l}} + 2\pi f X_{L}}
$$

with C_l the load capacitance (refer to the quartz crystal specification).

Example:

10.18 MHz: $C_L = 12 pF$ $X_L = 870 Ω$ $C_S = 7.2 pF$

This value may be obtained by putting two capacitors in series to the quartz, such as 18pF and 22pF in the 5.1MHz case and 18pF and 12pF in the 10.2MHz case.

4.4 Quartz Frequency Calculation

As described in [Section 3.4.3](#page-17-3) the operating range of the on-chip VCO is wide enough to guarantee a receive frequency range between 310 and 350MHz. The VCO signal is divided by 2 before applied to the mixer . This local oscillator signal can be used to downconvert the RF signals both with high- or low-side injection at the mixer. High-side injection of the local oscillator has to be used for receive frequencies between 310 and 330 MHz. In this case the local oscillator frequency is calculated by adding the IF frequency (10.7 MHz) to the RF frequency. In this case the higher frequency of a FSK-modulated signal is demodulated as a logical one (high).

Low-side injection has to be used for receive frequencies between 330 and 350 MHz. The local oscillator frequency is calculated by subtracting the IF frequency (10.7 MHz) from the RF frequency then. Please note that in this case sign-inversion occurs and the higher frequency of a FSK-modulated signal is demodulated as a logical zero (low). The overall division ratios in the PLL are 64 or 32 depending on whether the CSEL-pin is left open or tied to ground.

Therefore the quartz frequency may be calculated by using the following formula:

$$
f_{\text{QU}} = (f_{\text{RF}} \pm 10.7) / \text{r}
$$

- with f_{RF} receive frequency
	- f_{LO} local oscillator (PLL) frequency ($f_{\text{RF}} \pm 10.7$)
	- f_{QU} quartz oscillator frequency
	- r ratio of local oscillator (PLL) frequency and quartz frequency as shown in the subsequent table

This yields the following examples:

CSEL tied to GND:

$$
f_{\text{QU}} = (315 MHz + 10.7 MHz) / 32 = 10.1781 MHz
$$

$$
f_{\text{QU}} = (345 MHz - 10.7 MHz) / 32 = 10.4469 MHz
$$

CSEL open:

$$
f_{\text{QU}} = (315 \, MHz + 10.7 \, MHz) / 64 = 5.0891 \, MHz
$$
\n
$$
f_{\text{QU}} = (345 \, MHz - 10.7 \, MHz) / 64 = 5.2234 \, MHz
$$

4.5 Data Slicer Threshold Generation

The threshold of the data slicer can be generated using an external R-C integrator as shown in [Figure 4-5](#page-26-2). The cut-off frequency of the R-C integrator has to be lower than the lowest frequency appearing in the data signal. In order to keep distortion low, the minimum value for R is 20kΩ.

Figure 4-5 Data Slicer Threshold Generation with External R-C Integrator

In case of ASK operation another possibility for threshold generation is to use the peak detector in connection with two resistors and one capacitor as shown in the following figure. The component values are depending on the coding scheme and the protocol used.

Data_slice2.wmf

Figure 4-6 Data Slicer Threshold Generation Utilising the Peak Detector

4.6 ASK/FSK Switch Functional Description

The TDA5211 is containing an ASK/FSK switch which can be controlled via Pin 15 (MSEL). This switch is actually consisting of 2 operational amplifiers that are having a gain of 1 in case of the ASK amplifier and a gain of 11 in case of the FSK amplifier in order to achieve an appropriate demodulation gain characteristic. In order to compensate for the DC-offset generated especially in case of the FSK PLL demodulator there is a feedback connection between the threshold voltage of the bit slicer comparator (Pin 20) to the negative input of the FSK switch amplifier. This is shown in the following figure.

Figure 4-7 ASK/FSK mode datapath

4.6.1 FSK Mode

The FSK datapath has a bandpass characterisitc due to the feedback shown above (highpass) and the data filter (lowpass). The lower cutoff frequency f2 is determined by the external RC-combination. The upper cutoff frequency f3 is determined by the data filter bandwidth.

The demodulation gain of the FSK PLL demodulator is 140µV/kHz. This gain is increased by the gain v of the FSK switch, which is 11. Therefore the resulting dynamic gain of this circuit is 1.5mV/kHz within the bandpass. The gain for the DC content of FSK signal remains at 140µV/kHz. The cutoff frequencies of the bandpass have to be chosen such that the spectrum of the data signal is influenced in an acceptable amount.

In case that the user data is containing long sequences of logical zeroes the effect of the drift-off of the bit slicer threshold voltage can be lowered if the offset voltage inherent at the negative input of the slicer comparator (Pin20) is used. The comparator has no hysteresis built in.

This offset voltage is generated by the bias current of the negative input of the comparator (i.e. 20nA) running over the external resistor R. This voltage raises the voltage appearing at pin 20 (e.g. 1mV with $R = 100kΩ$). In order to obtain benefit of this asymmetrical offset for the demodulation of long zeros the lower of the two FSK frequencies should be chosen in the transmitter as the zerosymbol frequency.

In the following figure the shape of the above mentioned bandpass is shown.

Figure 4-8 Frequency characterstic in case of FSK mode

The cutoff frequencies are calculated with the following formulas:

$$
f_1 = \frac{1}{2\pi \frac{R \cdot 330k\Omega}{R + 330k\Omega} \cdot C}
$$

$$
f_2 = v \cdot f_1 = 11 \cdot f_1
$$

$$
f_3 = f_{3dB}
$$

 f_3 is the 3dB cutoff frequency of the data filter - see [Section 4.2.](#page-23-0)

Example: $R = 100k\Omega$, $C = 47nF$ This leads to f_1 = 44Hz and f_2 = 485Hz

4.6.2 ASK Mode

In case the receiver is operated in ASK mode the datapath frequency charactersitic is dominated by the data filter alone, thus it is lowpass shaped.The cutoff frequency is determined by the external capacitors C12 and C14 and the internal 100k resistors as described in [Section 4.2](#page-23-0)

Figure 4-9 Frequency charcteristic in case of ASK mode

4.7 Principle of the Precharge Circuit

In case the data slicer threshold shall be generated with an external RC network as described in [Section 4.5](#page-26-0) it is necessary to use large values for the capacitor C attached to the **SLN** pin (pin 20) in order to achieve long time constants. This results also from the fact that the choice of the value for R connected between the **SLP** and **SLN** pins (pins 19 and 20) is limited by the 330kΩ resistor appearing in parallel to R as can be seen in [Figure 4-7](#page-27-3). Apart from this a resistor value of 100kΩ leads to a voltage offset of 1mv at the comparator input as described in [Section 4.6.1.](#page-27-1) The resulting startup time constant τ_1 can be calculated with:

 $τ_1 = (R // 330kΩ) · C$

In case R is chosen to be 100kΩ and C is chosen as 47nF this leads to

 $τ_1 = (100kΩ // 330kΩ) · 47nF = 77kΩ · 47nF = 3.6ms$

When the device is turned on this time constant dominates the time necessary for the device to be able to demodulate data properly. In the powerdown mode the capacitor is only discharged by leakage currents.

In order to reduce the turn-on time in the presence of large values of C a precharge circuit was included in the TDA5211 as shown in the following figure.

precharge.WMF

Figure 4-10 Principle of the precharge circuit

This circuit charges the capacitor C with an inrush current I_{load} of typically 220µA for a duration of T_2 until the voltage U_c appearing on the capacitor is equal to the voltage U_s at the input of the data filter. This voltage is limited to 2.5V. As soon as these voltages are equal or the duration T_2 is exceeded the precharge circuit is disabled.

 τ_2 is the time constant of the charging process of C which can be calculated as

τ₂ ≈ 20kΩ · C2

as the sum of R1 and R2 is sufficiently large and thus can be neglected. T2 can then be calculated according to the following formula:

$$
T_2 = \tau_2 \ln \left(\frac{1}{1 - \frac{2.4V}{3V}} \right) \approx \tau_2 \cdot 1.6
$$

The voltage transient during the charging of C2 is shown in the following figure:

Figure 4-11 Voltage appearing on C2 during precharging process

The voltage appearing on the capacitor C connected to pin 20 is shown in the following figure. It can be seen that due to the fact that it is charged by a constant current source it exhibits is a linear increase in voltage which is limited to U_{Smax} = 2.5V which is also the approximate operating point of the data filter input. The time constant appearing in this case can be denoted as T3, which can be calculated with

$$
T3 = \frac{U_{Smax} \cdot C}{220\mu A} = \frac{2.5V}{220\mu A} \cdot C
$$

Figure 4-12 Voltage transient on capacitor C attached to pin 20

As an example the choice of $C2 = 22nF$ and $C = 47nF$ yields

 $\tau_2 = 0.44$ ms $T_2 = 0.71$ ms $T_3 = 0.53$ ms

This means that in this case the inrush current could flow for a duration of 0.64ms but stops already after 0.49ms when the U_{Smax} limit has been reached. T3 should always be chosen to be shorter than T2.

It has to be noted finally that during the turn-on duration T2 the overall device power consumption is increased by the 220µA needed to charge C.

The precharge circuit may be disabled if C2 is not equipped. This yields a T2 close to zero. Note that the sum of R4 and R5 has to be 600kΩ in order to produce 3V at the THRES pin as this voltage is internally used also as the reference for the FSK demodulator.

Contents of this Chapter

5.1 Electrical Data

5.1.1 Absolute Maximum Ratings

WARNING

The maximum ratings may not be exceeded under any circumstances, not even momentarily and individually, as permanent damage to the IC will result.

5.1.2 Operating Range

Within the operational range the IC operates as explained in the circuit description. The AC/DC characteristic limits are not guaranteed. Currents flowing into the device are denoted as positive currents and v.v.

Supply voltage: VCC = 4.5V .. 5.5V

■ This value is guaranteed by design.

5.1.3 AC/DC Characteristics at T_{AMB} = 25°C

AC/DC characteristics involve the spread of values guaranteed within the specified voltage and ambient temperature range. Typical characteristics are the median of the production. Currents flowing into the device are denoted as positive currents and vice versa.

The device performance parameters marked with ■ were measured on an Infineon evaluation board as described in [Section 5.2.](#page-43-0)

f_{RF} = 315 MHz

Reference

CRYSTAL OSCILLATOR

Signals CRSTL1, CRISTL 2, (PINS 1/28)

ASK/FSK Signal Switch

FSK DEMODULATOR

POWER DOWN MODE

■ Measured only in lab.

5.1.4 AC/DC Characteristics at T_{AMB} = -40 to 105°C

Currents flowing into the device are denoted as positive currents and vice versa.

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preliminary

Reference

5.2 Test Circuit

Infineon

The device performance parameters marked with ■ in [Section 5.1.3](#page-36-0) were measured on an Infineon evaluation board. This evaluation board can be obtained together with evaluation boards of the accompanying transmitter device TDA5101 in an evaluation kit that may be ordered on the INFINEON RKE Webpage www.infineon.com/rke. In case a matching codeword is received, decoded and accepted by the decoder the on-board LED will turn on. This signal is also accessible on a 2-pole pin connector and can be used for simple remote-control applications. More information on the kit is available on request.

5.3 Test Board Layouts

tda521x_testboard_20_top.WMF

Figure 5-2 Top Side of the Evaluation Board

tda521x_testboard_20_bot.WMF

Figure 5-3 Bottom Side of the Evaluation Board

Reference

tda521x_testboard_20_plc.EMF

5.4 Bill of Materials

The following components are necessary for evaluation of the TDA5211 at 315 MHz without use of a Microchip HCS512 decoder.

Please note that a capacitor has to be soldered in place L2 and an inductor in place C6.

The following components are necessary in addition to the above mentioned ones for evaluation of the TDA5211 in conjunction with a Microchip HCS512 decoder.

5.5 Appendix - Noise Figure and Gain Circles

The following gain and noise figure circles were measured utilizing Microlab Stub Stretchers and a HP8514 network analyser. Maximum gain is shown at point 1 at 18.5 dB, minimum noise figure ist 1.9dB at point 2, step size of circles is 0.5dB.

Figure 5-5 Gain and Noise Circles of the TDA5211 at 315 MHz.

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